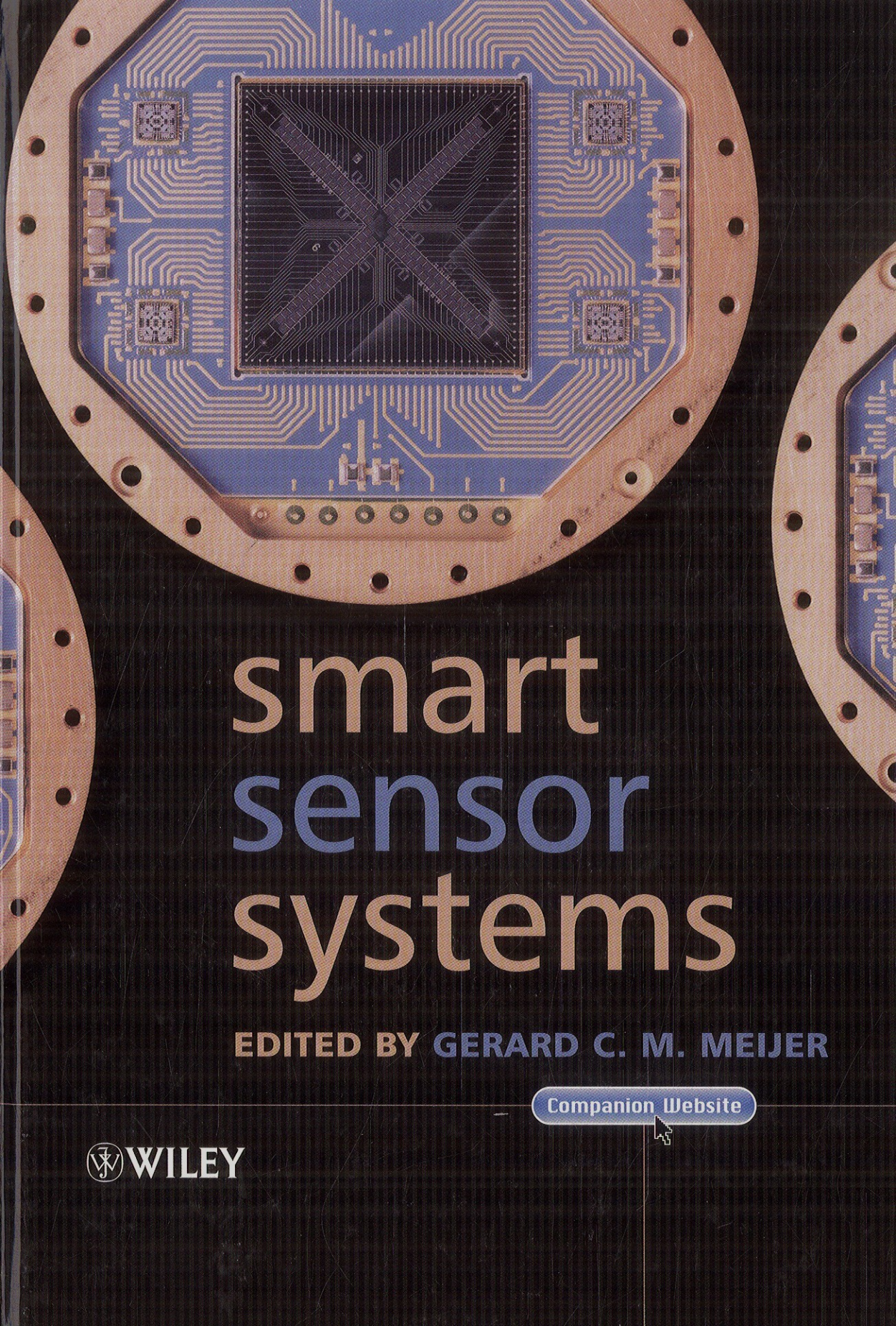




smart sensor systems

EDITED BY GERARD C. M. MEIJER

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Solutions to Problems can be found on the Companion website